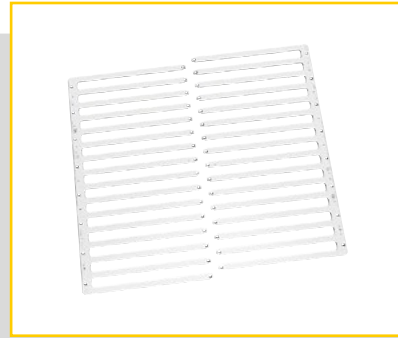


LED LIGHT PANEL SMD

WU-M-607 (256x509.5)



LED LIGHT PANEL SMD – LED MODULES FOR OFFICE LIGHTING

WU-M-607

Typical Applications

Built-in luminaires/general illumination

- Office lighting, especially grid luminaires 600x600 mm
- Retail lighting
- T5/T8 replacement as built-in module
- Furniture lighting
- Backlighting for advertising



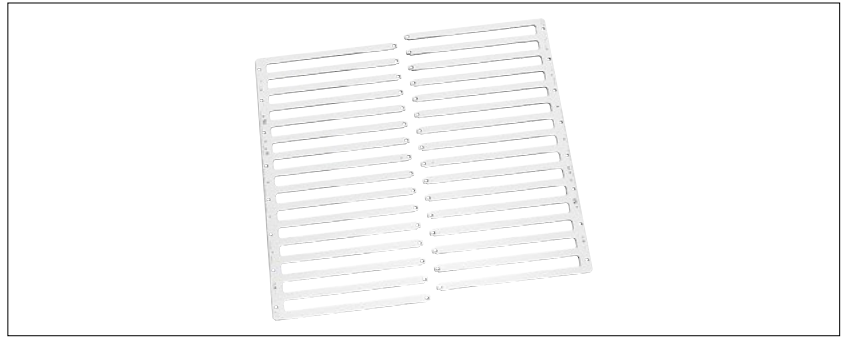
LED Light Panel SMD

- **LONG SERVICE LIFE TIME: 50,000 H (L80/B10)**
- **HIGHLY EFFICIENT: UP TO 178 LM/W
AT T_p = 50 °C**

LED Light Panel SMD

Technical Notes

- LED built-in module for integration into luminaires
- Dimensions: 256x509.5 mm
- Driving current: 250 mA / 350 mA / 500 mA / 700 mA
- On-board push-in terminals
- Colour tolerance: 2-step MacAdam (per bin)
- No. of SMDs: 128 pcs.



Electrical Characteristics

at $t_p = 50\text{ °C}$

Type	No. of SMDs	Typ. voltage DC [V]				Typ. power consumption [W]			
		250 mA	350 mA	500 mA	700 mA	250 mA	350 mA	500 mA	700 mA
WU-M-607	128	44.4	44.8	45.4	46.3	11.1	15.7	22.7	32.4

Voltage and power consumption tolerance: $\pm 10\%$

Use of external LED constant current driver required.

Maximum Ratings

Exceeding the maximum ratings can lead to reduction of service life or destruction of the module.

Type	Operating current mA	Operation temperature range at t_c point		Storage temperature range		Max. allowed repetitive peak current mA
		$^{\circ}\text{C}$ min.	$^{\circ}\text{C}$ max.	$^{\circ}\text{C}$ min.	$^{\circ}\text{C}$ max.	
WU-M-607	all	-20	+75	-20	+80	1600

Operating Life

In hours at measured temperature at t_p point

Temperature	L80/B10				L70/B10			
	I_f 250 mA	I_f 350 mA	I_f 500 mA	I_f 700 mA	I_f 250 mA	I_f 350 mA	I_f 500 mA	I_f 700 mA
at $t_p = 45\text{ °C}$	> 54,000	> 54,000	> 54,000	51,000	> 54,000	> 54,000	> 54,000	> 54,000
at $t_p = 55\text{ °C}$	> 54,000	> 54,000	> 54,000	48,000	> 54,000	> 54,000	> 54,000	> 54,000
at $t_p = 75\text{ °C}$	> 54,000	> 54,000	> 54,000	40,000	> 54,000	> 54,000	> 54,000	> 54,000

Optical Characteristics

at $t_p = 50\text{ °C}$

Type	Ref. No.	Colour	Correlated colour temperature* K	Typ. luminous flux (lm) and efficiency** (lm/W) at								Min. CRI R_a	Beam angle $^{\circ}$	Photo-metric code
				250 mA		350 mA		500 mA		700 mA				
				typ. lm	typ. lm/W	typ. lm	typ. lm/W	typ. lm	typ. lm/W	typ. lm	typ. lm/W			
WU-M-607-830	566971	warm white	3000	1835	165	2530	161	3545	156	4820	149	80	120	830/479
WU-M-607-840	566972	neutral white	4000	1935	174	2670	170	3740	165	5085	157	80	120	840/479
WU-M-607-850	568514	cool white	5000	1970	178	2720	173	3805	167	5180	160	80	120	850/479
WU-M-607-865	566973	cool white	6500	1900	171	2620	167	3670	162	4995	154	80	120	865/479

* Colour tolerance: 4 MacAdam | ** Production tolerance of luminous flux and efficiency: $\pm 10\%$

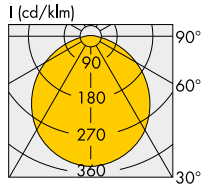
Minimum order quantity (packaging unit): 42 pcs.

The values contained in this data sheet can change due to technical innovations. Any such changes will be made without separate notification.

LED Light Panel SMD

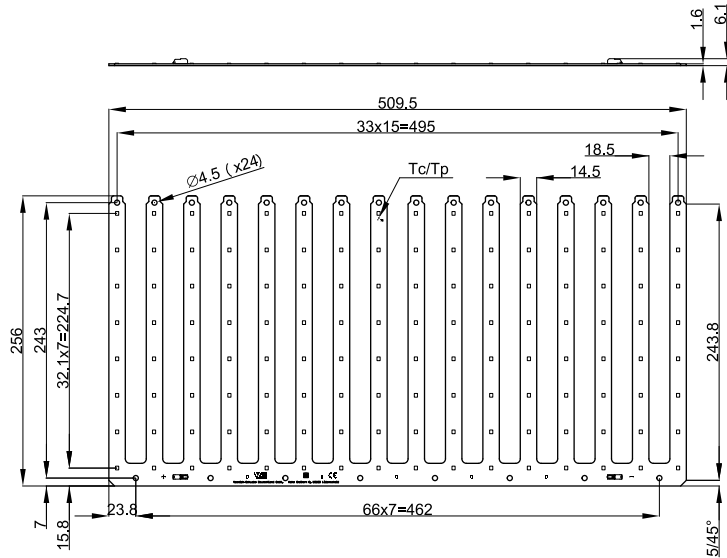
Typical Light Distribution Curve

Data are available in .ldt format for download under www.vossloh-schwabe.com.

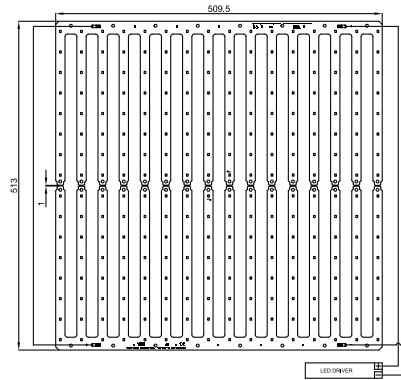


Mechanical Dimensions

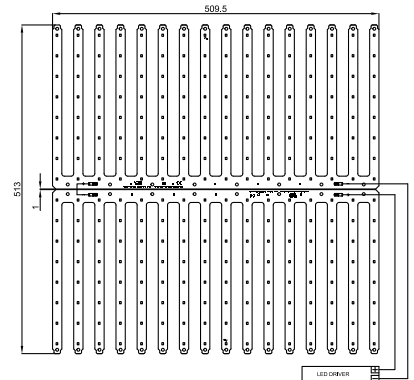
- The number of modules that can be connected in series depends on the available output voltage of the LED driver.
- The clearance and creepage distances are designed for working voltages up to 500 V DC (basic insulation) and 250 V DC (reinforced insulation).
- Max. diameter of screw head (M4): \varnothing 8 mm



Connection Example 1

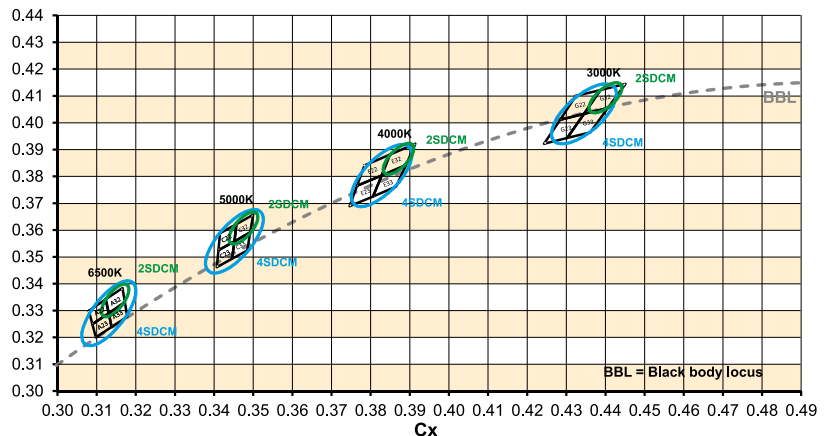


Connection Example 2



Bins

The standard shipping format regarding the reference numbers includes all chromaticity coordinate groups. The chromaticity coordinate groups of 2-step MacAdam distribution (E22, E32,...) can be identified on the product and packaging label.



The values contained in this data sheet can change due to technical innovations. Any such changes will be made without separate notification.

LED Light Panel SMD

Fixing Clip

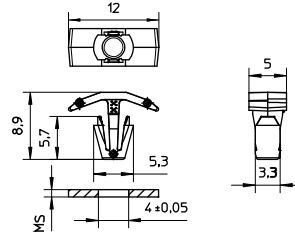
For fastening LED PCBs to luminaire sheets without needing screws

PCB hole dia.: 4.3–4.7 mm

Vibration resistant version

Material: PC, white (UL-94 V2)

Weight: 0.2 g, Packaging unit: 1000 pcs. (.11 = 10,000 pcs.)



Type	Ref. No.	For luminaire sheet thickness (MS) mm
98050	562870	0.5–1.0*

* PCB thickness: 1.6 mm

LED Constant Current Drivers

Please visit our homepage for details for suitable

LED constant current drivers: www.vossloh-schwabe.com

Assembly and Safety Information

Installation must be carried out under observation of the relevant regulations and standards. The LED modules are designed for operation within a casing or luminaire. Installation must be carried out in a voltage-free state (i.e. disconnection from the mains). The following advice must be observed; non-observance can result in the destruction of the LED assembly modules, fire and/or other hazards.

- Consider safety regulations acc. EN 60598 in the luminaire design, especially when the operating LED driver is not galvanic isolated (not SELV).
 - In mode of operation regard to sufficient isolation.
 - Live parts must not be touched in operation mode.
- ESD (electrostatic discharge) protection measures must be observed when handling and installing the LED modules. See VS's application notes on ESD protection.
- Adequate anti-static electricity measures, including the use of conductive shoes, ionizers, work bench grounding, wrist straps, flooring and stools could be used.
- LED assembly modules must not be subjected to any undue mechanical stress, e. g.:
 - do not treat as bulk cargo
 - avoid shear and compressive forces during handling and installation
 - do not damage circuit paths
 - avoid any pressure on the light emitting surface



- Safe operation only possible by the use of external constant current sources (I_{max} , see table "Electrical Characteristics").
- Operation only with power supply units that feature the following protection:
 - Short-circuit protection
 - Overload protection
 - Overheating protection
- Please ensure the correct polarity of the leads prior to commissioning. Reversed polarity can destroy the modules.
- For interconnection the LED modules is equipped with push-in terminals (WAGO 2060).
- Safety regulations acc. to EN 60598 (or further standards) has to be observed if the maximum output voltage exceed the permitted touchable value.
- The following points must be observed when connecting LED modules in parallel:
 - All LED strings that are wired in parallel must contain the same number of LEDs (symmetrical loading).
 - Owing to differing forward biases, there can be a difference of up to 10% in brightness between modules connected in parallel.
- To ensure problem-free operation, the specified maximum temperature at the T_p point (see "Operating Life") must be observed (and measured in accordance with EN 60598-1). To satisfy this point, it may be necessary to put measures in place to ensure any heat is dissipated from the PCB to the environment.

The values contained in this data sheet can change due to technical innovations. Any such changes will be made without separate notification.

LED Light Panel SMD

Assembly and Safety Information

- Products equipped with adhesive transfer tape must only be applied to dry and clean surfaces that are free from grease, oil, silicone or other soiling. It is therefore recommended to clean the substrate with isopropyl alcohol (IPA). Please ensure a full-surface bond over the entire contact area when sticking the module to the substrate.

The following substances are regarded as critical for creating an adhesive bond:

- Polyefins (polyethylene, polypropylene)
- Rubber
- Powdercoated materials
- Silicone rubber
- Teflon

Owing to the varying application options and different types of surface as well as ambient conditions, VS accepts no liability for the quality of the adhesive bond achieved when mounting these products. Prior to sticking a VS product care must be taken to check whether the material in question is actually suitable for the intended purpose under consideration of all possible application-relevant influences. Supplementary holders must be used if necessary.

- In the event of outdoor applications or applications in damp locations, care must be taken to protect LED assembly modules against humidity, splashes and jets of water. Any corrosion damage resulting from humidity or contact with condensation will not be recognised as a defect or manufacturing fault. LED assembly modules are not specially protected against foreign bodies or dust. Depending on the type of application, further protection must be ensured to prevent dust and foreign bodies from entering.
- Due to the manufacturing process, the PCBs of the LED assembly modules can have sharp edges and corners. Care must therefore be taken during handling and installation to avoid injury.
- For optimal load of used constant current driver the modules can only be connected in series. The quantity of LED modules is limited by the sum of forward voltage and the capacity of used constant current driver. Safety regulations acc. to EN 60598 has to be observed if the sum of forward voltage exceed the permitted touchable value.
- Operating LED modules in the presence of certain chemical substances or in chemically enriched (aggressive) environments can impair module functionality or even cause total module failure. Detailed information can be found in our "Chemical Incompatibility" PDF on our website www.vossloh-schwabe.com
- The photobiological safety of the LED modules must be classified into risk groups in accordance with EN 62471: 2008
Assessment of risk groups in acc. with IEC/TR 62778: risk group 1

Applied Standards

EN 62031
LED modules for general lighting – Safety specifications

EN 62471
Photobiological safety of lamps and lamp system

Product Guarantee

- 5 years
- The conditions for the Product Guarantee of the Vossloh-Schwabe Group shall apply as published on our homepage (www.vossloh-schwabe.com). We will be happy to send you these conditions upon request.

The values contained in this data sheet can change due to technical innovations. Any such changes will be made without separate notification.